

Patents Form P9

Maintaining application for standard patent (R)

Patents Ordinance (Cap. 514)

Patents (General) Rules (Cap. 514C)

Important notes

1. General notes:

- a. Please complete this form in English unless otherwise stated.
- b. By submitting this form, you will be treated as having given consent to the Patents Registry and its service provider to copy or communicate all the information provided to any third party (in or outside Hong Kong) who assists or supports the Patents Registry in performing its functions under the Patents Ordinance, Cap. 514 and its subsidiary legislation.
- c. This form must be signed and dated.
- d. If there is not enough space for any part on this form, please continue on an additional sheet. Number each additional sheet and state the number of additional sheet(s).
- e. Please provide a name and contact address in Hong Kong for correspondence.
- f. Please enquire through the following means:
 - E-mail: enquiry@ipd.gov.hk
 - Internet homepage address: www.ipd.gov.hk
 - The Patents Ordinance, Cap 514 and Patents (General) Rules, Cap 514C can be viewed at www.ipd.gov.hk.

2. Use of personal data:

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Personal data collected by the Registrar of Patents ("the Registrar") in the forms filed with the Registrar will be used for the purposes set out in the Personal Information Collection Statement at <u>https://www.ipd.gov.hk/eng/personal_information.htm</u>.

3. Use of other information:

- The Patents Registry will use any information relating to any commercial enterprise or entity provided in this form a. and any document(s) filed in relation to it for processing your application, request or notice, and for the purposes Personal Information Collection of collection set out in the Statement at https://www.ipd.gov.hk/eng/personal information.htm. They may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.
- b. **DO NOT include any business information of your own or that of third parties which you consider to be confidential or commercially sensitive.** Where such information is included in this form or any document(s) filed in relation to it, the Registrar will treat it an express and voluntary consent given by you and any such third party to disclosure of all such information for the purpose of public inspection.

4. Submission of application/request/notice:

- a. In person or by mail with the appropriate fee to the Registrar of Patents, 24/F, Wu Chung House, No. 213 Queen's Road East, Wanchai, Hong Kong. The fee schedule can be viewed at <u>www.ipd.gov.hk/eng/forms_fees.htm</u>. Payment can be made in person by cash, or by sending a cheque/bank draft (in Hong Kong dollars which can be cleared in Hong Kong) made payable to THE GOVERNMENT OF THE HONG KONG SPECIAL ADMINISTRATIVE REGION.
- b. This form can also be submitted electronically. For details, please visit <u>IPD's e-Filing System</u>.

1	*Den	otes	mandatory	fields
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01. Reference

Filer's reference

02. *Application no.

Application no.

This form is for one patent application.

03. *Full name of the applicant(s)

(a) Name in English

(b)	Name in Chinese	
	(if applicable)	

04. *Statements in support

The date entered in box (a) should not be earlier than one month before the date of making the maintenance application. (Section 33(5), Patents Ordinance)

*(a) Date on which the statements in box (b) are valid	DD-MM-YY	YY
*(b) Statements in support Please mark the appropriate box(es).		The designated patent application has not been withdrawn or abandoned in the designated patent office.
		The designated patent application has not been finally refused in the designated patent office.
		The designated patent has not been granted.
		The designated patent has been granted. The patent was granted on a date within six months before the date of the maintenance application.
		Date of grant of the designated patent
		DD-MM-YYYY

05. *Payment of maintenance fee (and additional fee for late payment)

You should pay the maintenance fee before the expiry date (but not earlier than three months before the expiry date). You can still apply to maintain the patent application within six months after the expiry date but you have to pay the prescribed additional fee.

*(a) Due date of maintenance fee	DD-MM-YYYY			
(b) Are you paying late? Please mark <u>one</u> box only and provide the no. of months late if applicable.		Yes	months late	
		Νο		
(c) Are you paying an additional fee?		Yes		
Please mark <u>one</u> box only.		Νο		

06. Overdue payment notice

Overdue payment notice will be sent to the address for service recorded on the register. If you wish the notice to be sent to an address in Hong Kong other than the address for service, please complete this part. (Sections 28(2) and (3), Patents (General) Rules)

(a) Name

(b) Address

Flat/Floor/Building

Street/District

HONG KONG

07. *Contact details of person filing this application

*(a) Name	
*(b) Address You must provide an address in <u>Hong</u> <u>Kong.</u> Please note that a P.O. Box or "care of" address is not acceptable.	Flat/Floor/Building
	Street/District
	HONG KONG
(c) Telephone no. In Hong Kong	
(d) Fax no. In Hong Kong	

08. *Signature

I/We confirm that I/we have read and understood the "Important notes" of this form.		
*(a) Authorized signature		
*(b) Name of signatory		
*(c) Official capacity of signatory E.g. Authorized person, Director, Partner or Principal Officer of Applicant(s)/Agent, Applicant in person		
*(d) Date	DD-MM-YYYY	

09. Attachment(s)

Total number of attachment(s)